

(1.27 mm) .050"

**CLP SERIES** 

**OTHER** 

# -PROFILE DUAL WIPE SOCKET

NO. PINS

## **SPECIFICATIONS**

For complete specifications and recommended PCB layouts see www.samtec.com?CLP

Insulator Material: Black Liquid Crystal Polymer Contact Material: Phosphor Bronze

Phosphor Bronze
Plating:
Sn or Au over
50 μ" (1.27 μm) Ni
Current Rating (CLP/FTSH):
3.4 A per pin
(2 pins powered)
Voltage Rating:
280 VAC/395 VDC
Operating Temp Range:
-55 °C to +125 °C
Insertion Depth:
Top Fntry = (1.40 mm) 0.55"

Top Entry = (1.40 mm) .055" minimum, Bottom Entry = (2.41 mm) .095" minimum plus board thickness DH Entry = (2.31 mm) .091" to (2.67 mm) .105"

Normal Force: 60 grams (0.59 N) average

Max Cycles: 100 with 10 μ" (0.25 μm) Au RoHS Compliant:

### **PROCESSING**

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (02-35) (0.15 mm) .006" max (36-50)\* \*(.004" stencil solution may be available; contact IPG@samtec.com)

## **RECOGNITIONS**

For complete scope of recognitions see www.samtec.com/quality

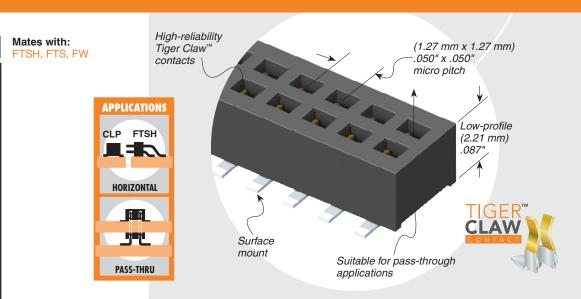


### ALSO AVAILABLE (MOQ Required)

- · Single row
- · Other platings Contact Samtec.

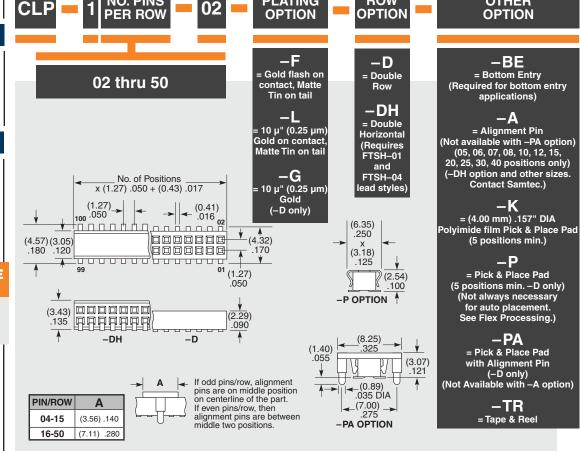
#### Note:

Some sizes, styles and options are non-standard, non-returnable.



**PLATING** 

**ROW** 



Due to technical progress, all designs, specifications and components are subject to change without notice.